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 TITLE: Thermosetting resin coating compositions for in-mold coating process
 INVENTOR(S): Morishita, Natsuki; Tsuji, Toshimitsu
 PATENT ASSIGNEE(S): Sekisui Chemical Co Ltd, Japan
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AB Thermosetting resin coating compns. (A), useful for providing good adhesion and good appearance for thermosetting resin molding compns. (B) which contain unsatd. (thio)isocyanates, consists of hydroxy-contg. unsatd. compds.; or vice versa, compns. A may contain unsatd. (thio)isocyanates, and B may contain hydroxy-contg. unsatd. compds. Thus, 60 parts glass fiber was impregnated with a compn. contg. 40% styrene soln. of isophthalic acid-maleic acid-polypropylene glycol copolymer (I) 60, polystyrene 30, allyl isocyanate 10, CaCO₃ 120, tert-Bu peroxybenzoate (II) 1, and powd. MgO 1 part to give a sheet molding compd., which was in-mold-coated with a compn. contg. I 100, CaCO₃ 10, 2-hydroxyethyl methacrylate 5, and II 1 part to give a test piece with good adhesion.